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Typical Applications

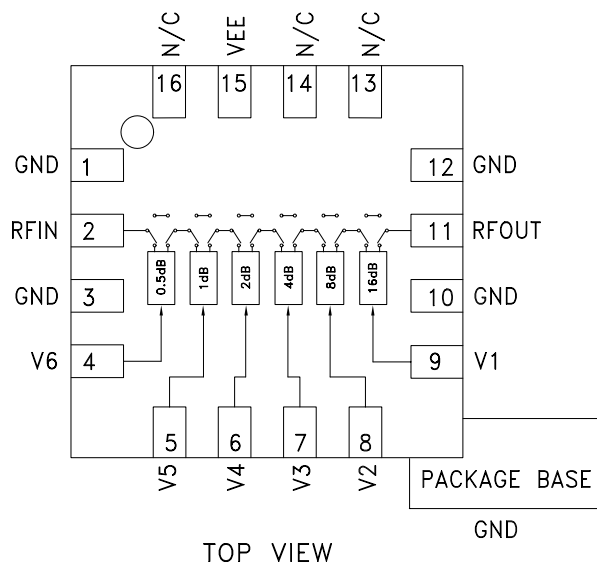
The HMC424ALP3E is ideal for:

- Basestation Infrastructure
- Fiber Optics & Broadband Telecom
- Microwave & VSAT Radios
- Military & Space
- Test Instrumentation

Features

- 0.5 dB LSB Steps to 31.5 dB
- Single Control Line Per Bit
- ± 0.5 dB Typical Bit Error
- 9mm² Leadless SMT Plastic Package

Functional Diagram



General Description

The HMC424ALP3E is a broadband 6-bit GaAs IC digital attenuator in low cost leadless surface mount package. Covering DC to 13 GHz, the insertion loss is less than 4 dB typical. The attenuator bit values are 0.5 (LSB), 1, 2, 4, 8, and 16 dB for a total attenuation of 31.5 dB. Attenuation accuracy is excellent at ± 0.5 dB typical step error with an IIP3 of +38 dBm. Six control voltage inputs, toggled between 0 and -5V, are used to select each attenuation state. A single Vee bias of -5V allows operation at frequencies down to DC.

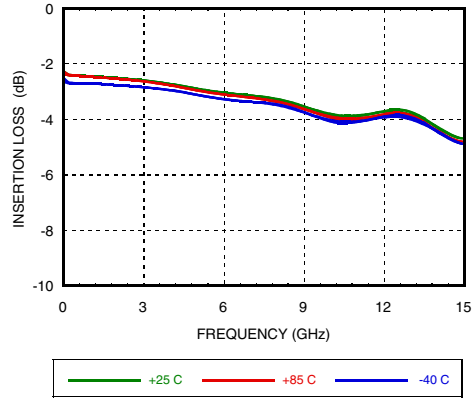
Electrical Specifications, $T_A = +25^\circ\text{C}$, With $V_{ee} = -5\text{V}$ & $V_{CTL} = 0/-5\text{V}$

Parameter	Frequency (GHz)	Min.	Typ.	Max.	Units
Insertion Loss	DC - 4 GHz		2.8	3.3	dB
	4.0 - 8.0 GHz		3.3	3.8	dB
	8.0 - 13.0 GHz		3.9	4.4	dB
Attenuation Range	DC - 13.0 GHz		31.5		dB
Return Loss (RF1 & RF2, All Atten. States)	DC - 13.0 GHz		13		dB
Attenuation Accuracy: (Referenced to Insertion Loss)	0.5 - 31.5 dB States	DC - 13.0 GHz	± (0.3 + 5% of Atten. Setting) Max		dB
Input Power for 0.1 dB Compression	1.0 - 13.0 GHz		23		dBm
Input Third Order Intercept Point (Two-Tone Input Power = +10 dBm Each Tone)	1.0 - 13.0 GHz	REF State	45		dBm
		All Other States	42		dBm
Switching Characteristics	DC - 13.0 GHz				
tRISE, tFALL (10/90% RF)			30		ns
tON/tOFF (50% CTL to 10/90% RF)			50		ns

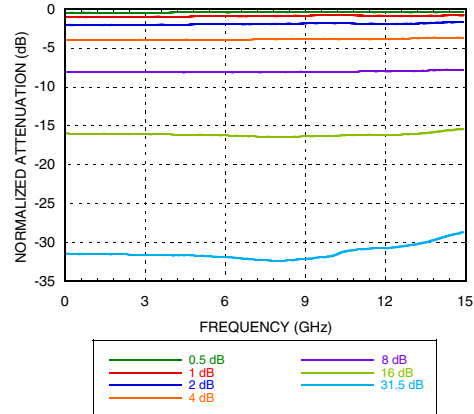


0.5dB LSB GaAs MMIC 6-BIT DIGITAL ATTENUATOR, DC - 13 GHz

Insertion Loss

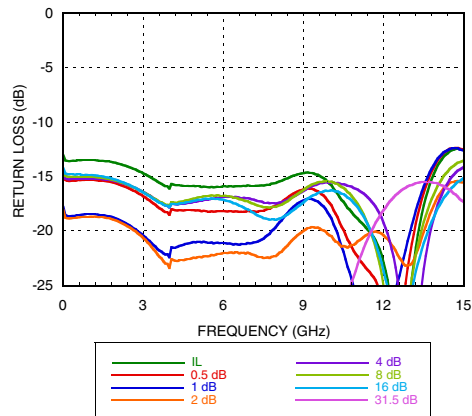


Normalized Attenuation
(Only Major States are Shown)



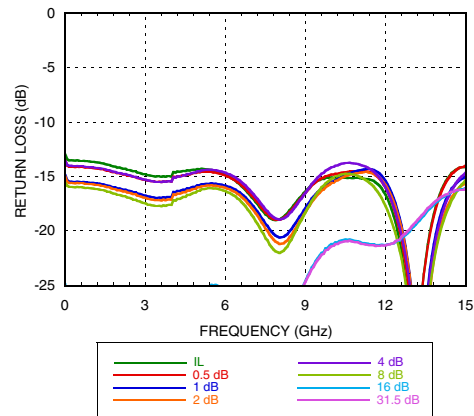
Input Return Loss

(Only Major States are Shown)



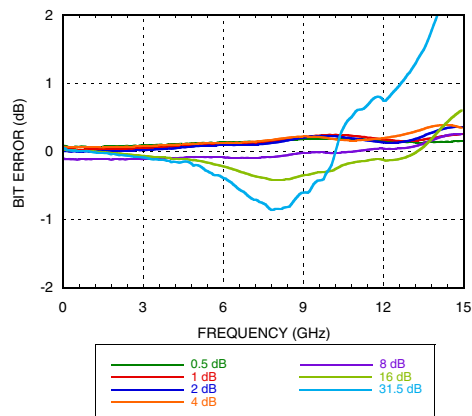
Output Return Loss

(Only Major States are Shown)

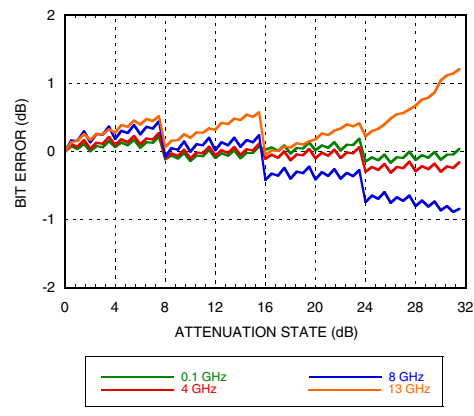


Bit Error vs. Frequency

(Only Major States are Shown)



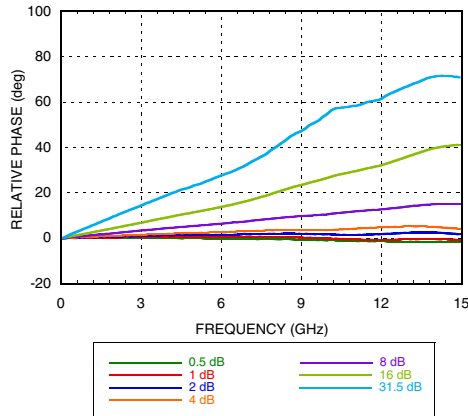
Bit Error vs. Attenuation State



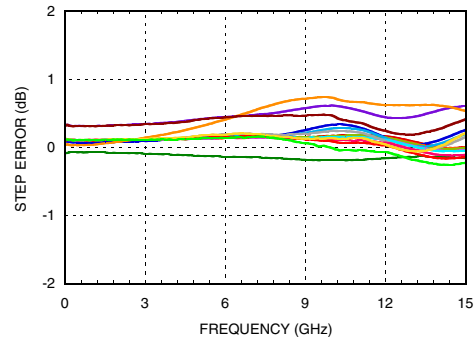


0.5dB LSB GaAs MMIC 6-BIT DIGITAL ATTENUATOR, DC - 13 GHz

Relative Phase vs. Frequency
(Only Major States are Shown)



Worst Case Step Error Between Successive Attenuation States



Truth Table

Control Voltage Input						Attenuation State RF1 - RF2
V1 16 dB	V2 8 dB	V3 4 dB	V4 2 dB	V5 1 dB	V6 0.5 dB	
Low	Low	Low	Low	Low	Low	Reference I.L.
Low	Low	Low	Low	Low	High	0.5 dB
Low	Low	Low	Low	High	Low	1 dB
Low	Low	Low	High	Low	Low	2 dB
Low	Low	High	Low	Low	Low	4 dB
Low	High	Low	Low	Low	Low	8 dB
High	Low	Low	Low	Low	Low	16 dB
High	High	High	High	High	High	31.5 dB

Any Combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Bias Voltage & Current

Vee Range= -5 Vdc ± 10%		
Vee (VDC)	Iee (Typ.) (mA)	Iee (Max.) (mA)
-5	2	5

Control Voltage

State	Bias Condition
Low	0 to -3V @ 35 µA Typ.
High	Vee to Vee +0.8V @ <1 µA Typ.



0.5dB LSB GaAs MMIC 6-BIT DIGITAL ATTENUATOR, DC - 13 GHz

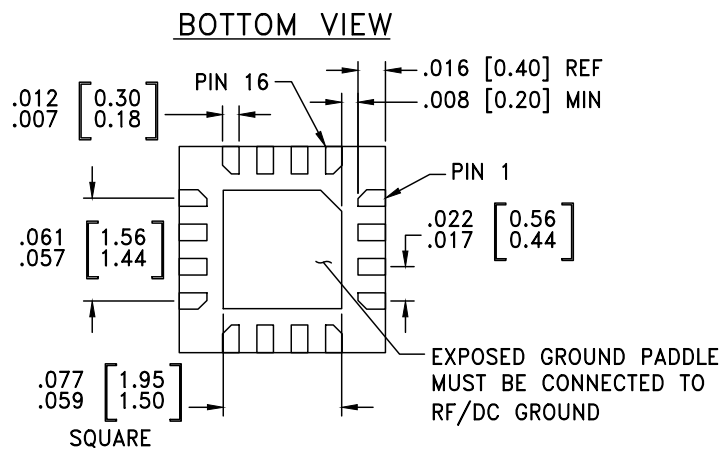
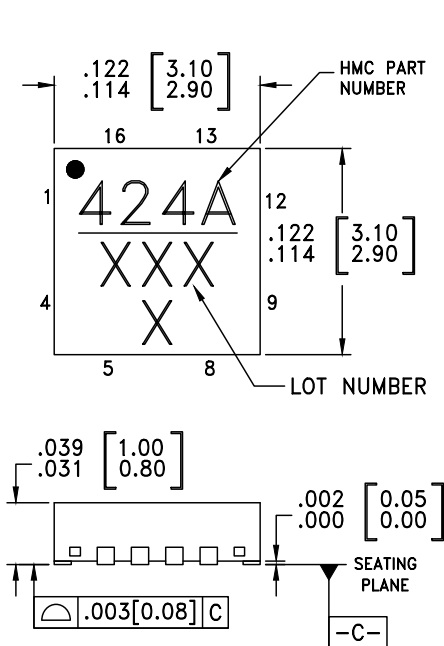
Absolute Maximum Ratings

Control Voltage (V1 to V6)	Vee - 0.5 Vdc
Bias Voltage (Vee)	-7 Vdc
Channel Temperature	150 °C
Thermal Resistance	330 °C/W
Storage Temperature	-65 to + 150 °C
Operating Temperature	-55 to +85 °C
RF Input Power (0.5 - 13 GHz)	+25 dBm
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.


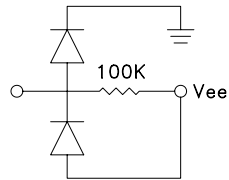

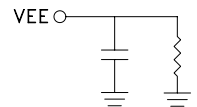
Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC424ALP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[1]	424A XXXX

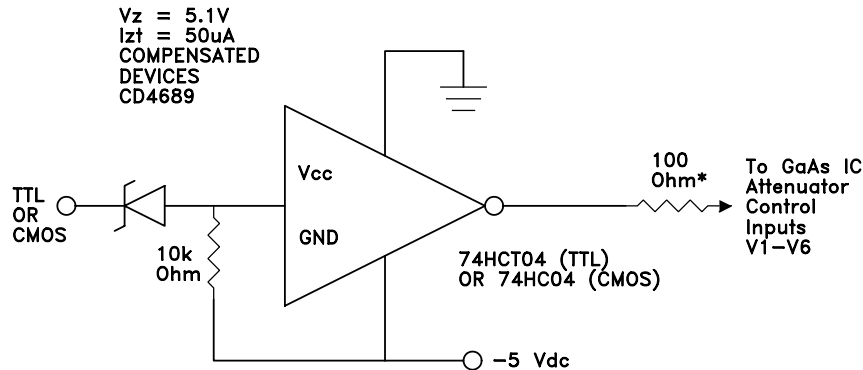
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX

Pin Description

Pad Number	Function	Description	Interface Schematic
1, 3, 10, 12	GND	Package bottom has an exposed metal paddle that must also be connected to RF ground	
2, 11	RFIN, RFOUT	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required if RF line potential is not equal to 0V.	
4, 5, 6, 7, 8, 9	V6 - V1	See truth table and control voltage table.	
13, 14, 16	N/C	This pin should be connected to PCB RF ground to maximize performance	
15	VEE	Supply Voltage -5V ± 10%	

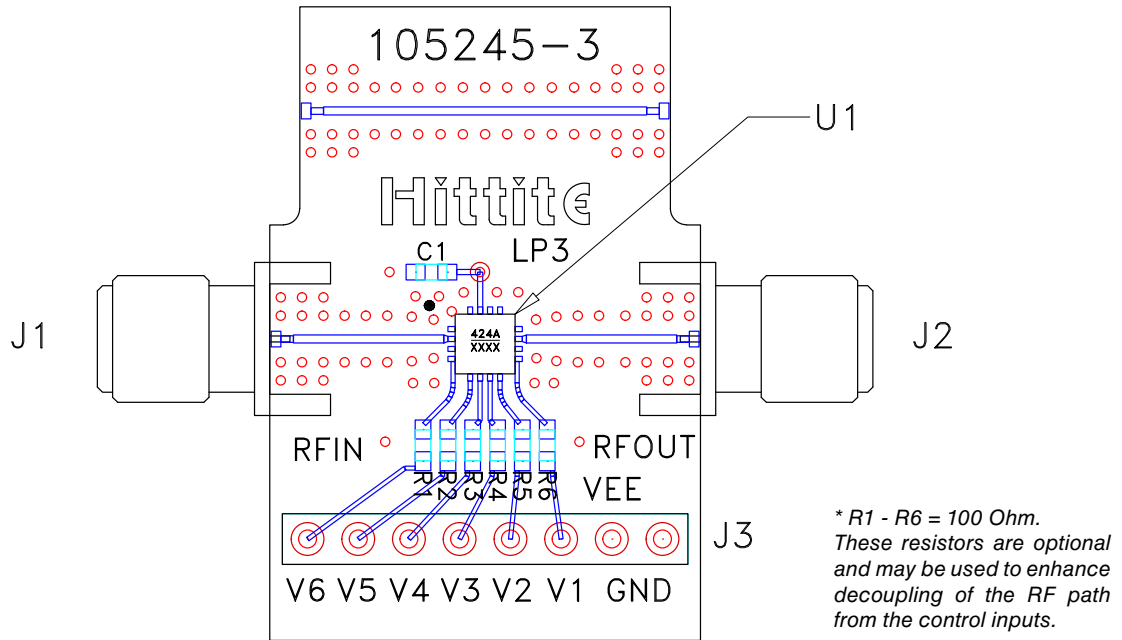
Suggested Driver Circuit (One Circuit Required Per Bit Control Input)



Simple driver using inexpensive standard logic ICs provides fast switching using minimum DC current.

* Recommended value to suppress unwanted RF signals at V1 - V6 control lines.

Evaluation PCB



List of Materials for Evaluation PCB EV1HMC424ALP3 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	8 Pin DC Connector
C1	0.01 μ F Capacitor, 0603 Pkg.
R1 - R6	100 Ohm Resistor, 0603 Pkg.
U1	HMC424ALP3E Digital Attenuator
PCB [2]	105245 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

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На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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